



On @ 6.5 Vin
 Off @ 6.3 Vin

3.3 V @ 1.1 A max load

max output current ripple = 0.5 A

PCB LOGO
 FCC disclaimer

PCB LOGO
 WEEE logo

PCB Number: PMP22021
 PCB Rev: B

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Orderable: ChangeMe in variant	Designed for: Public Release	Mod. Date: 6/4/2019
TID #: N/A	Project Title: 12Vin to 3.3Vout Isolated for AI/AO Modules	
Number: PMP22021	Rev: B	Sheet Title:
SVN Rev: Not in version control	Assembly Variant: 001	Sheet: 1 of 1
Drawn By:	File: PMP22021_Hardware.SchDoc	Size: A4
Engineer: John Dorosa	Contact: http://www.ti.com/support	



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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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